Power MOSFET 25 V, 78 A, Single N–Channel, DPAK

Features

- Low R_{DS(on)}
- Optimized Gate Charge
- Pb–Free Packages are Available

Applications

- Desktop VCORE
- DC–DC Converters
- Low Side Switch

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

				,	
Parame	Symbol	Value	Unit		
Drain-to-Source Voltage	V _{DSS}	25	V		
Gate-to-Source Voltage	V_{GS}	± 20	V		
Continuous Drain		$T_C = 25^{\circ}C$	I _D	14.8	А
Current (Note 1)		T _C = 85°C		11.5	
Power Dissipation (Note 1)		$T_C = 25^{\circ}C$	PD	2.3	W
Continuous Drain		$T_C = 25^{\circ}C$	Ι _D	11.4	А
Current (Note 2)	Steady	T _C = 85°C		8.8	
Power Dissipation (Note 2)	State	T _C = 25°C	PD	1.4	W
Continuous Drain	T _C = 25°C		I _D	78	А
Current (R _{0JC})		T _C = 85°C		56	
Power Dissipation $(R_{\theta JC})$		$T_C = 25^{\circ}C$	PD	64	W
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	210	А
Current Limited by Pack	age	$T_A = 25^{\circ}C$	I _{DmaxPkg}	45	А
Drain to Source dV/dt			dV/dt	8.0	V/ns
Operating Junction and S	T _J , T _{stg}	-55 to 175	°C		
Source Current (Body D	IS	78	А		
Single Pulse Drain-to-S Energy ($V_{DD} = 24 V$, V_{G} L = 5.0 mH, I _L (pk) = 17 /	E _{AS}	722.5	mJ		
Lead Temperature for So (1/8" from case for 10 so		Purposes	ΤL	260	°C

THERMAL RESISTANCE

Junction-to-Case (Drain)	R_{\thetaJC}	1.95	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	65	
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	110	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

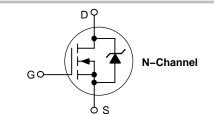
2. Surface-mounted on FR4 board using the minimum recommended pad size.

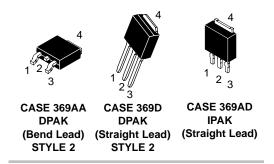


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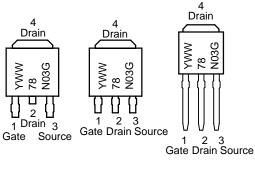
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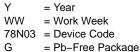
V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX
25 V	4.6 @ 10 V	78 A
25 V	6.5 @ 4.5 V	107





MARKING DIAGRAMS & PIN ASSIGNMENTS





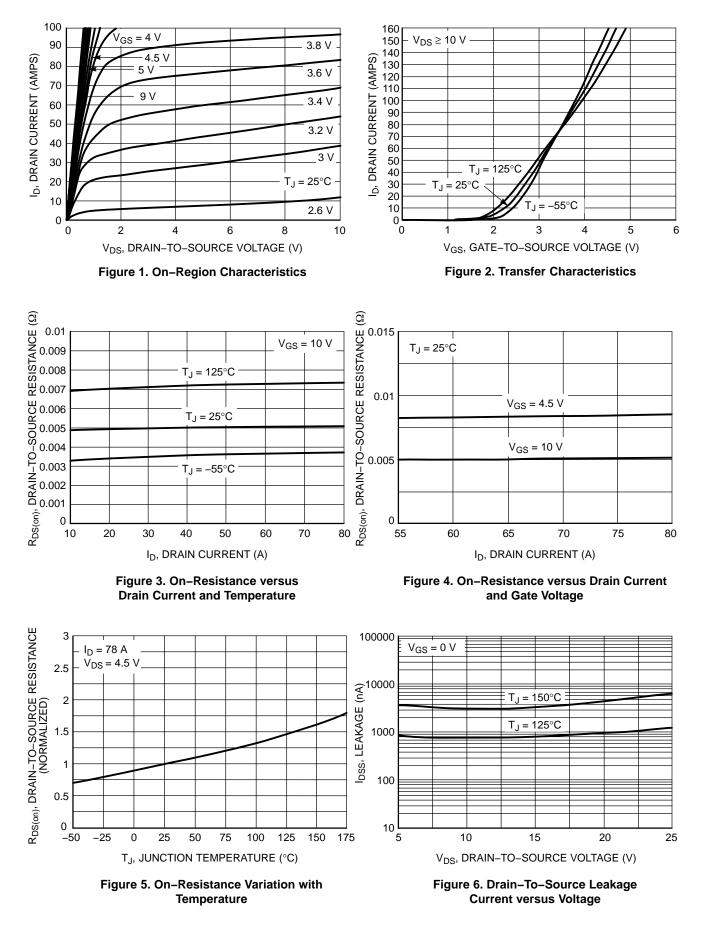
ORDERING INFORMATION

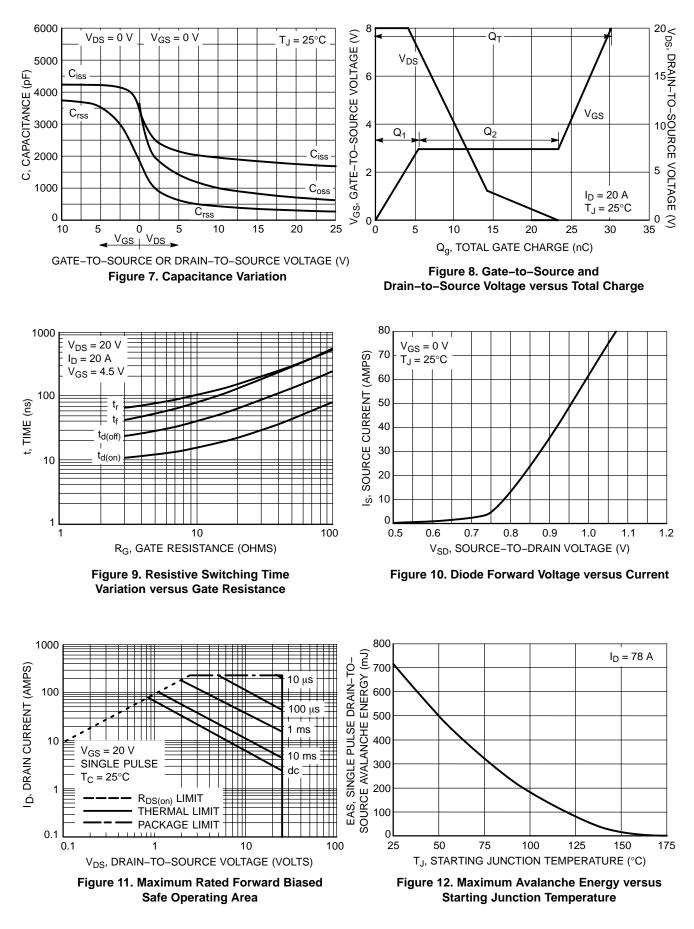
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Con	Min	Тур	Max	Unit	
OFF CHARACTERISTICS				_	_		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{C}$	₀ = 250 μA	25			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				24		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.5	μΑ
		$V_{\rm DS} = 20$ V	T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{C}$	_{SS} = ±20 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{I}$	_D = 250 μA	1.0	1.6	3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,	l _D = 78 A		4.6	6.0	mΩ
		V _{GS} = 4.5 V,	I _D = 36 A		6.5	7.8	
Forward Transconductance	gFS	V _{DS} = 10 V,	I _D = 15 A		22		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCE						
Input Capacitance	C _{iss}				1920	2250	
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = V _{DS} = 1	= 1.0 MHz, 12 V		960		pF
Reverse Transfer Capacitance	C _{rss}	• 05 -		420		1	
Total Gate Charge	Q _{G(TOT)}				25.5	35	-
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V	/ns = 20 V.		2.4		
Gate-to-Source Charge	Q _{GS}	$I_D = 2$		5.3		- nC	
Gate-to-Drain Charge	Q _{GD}			18.2			
SWITCHING CHARACTERISTICS (Note 4)						I.	
Turn–On Delay Time	t _{d(on)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V},$ $I_D = 20 \text{ A}, R_G = 3.0 \Omega$			11		- ns
Rise Time	t _r				68		
Turn–Off Delay Time	t _{d(off)}				23		
Fall Time	t _f				42		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S	•			•	1	
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.83	1.0	V
		$I_{\rm S} = 20 {\rm A}$	T _J = 125°C		0.7		
Reverse Recovery Time	t _{RR}				39		
Charge Time	ta	$V_{GS} = 0 V. dls/c$	t = 100 A/us.		17.8		ns
Discharge Time	tb	$V_{GS} = 0 V$, dls/c $I_S = 2$		21		1	
Reverse Recovery Time	Q _{RR}	1		33		nC	
PACKAGE PARASITIC VALUES						•	•
Source Inductance	L _S				2.49		
Drain Inductance	L _D	1			0.02		nH
Gate Inductance	L _G	- Ta = 2	25C		3.46		
Gate Resistance	R _G	1			1.0		Ω

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.





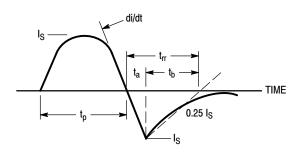


Figure 13. Diode Reverse Recovery Waveform

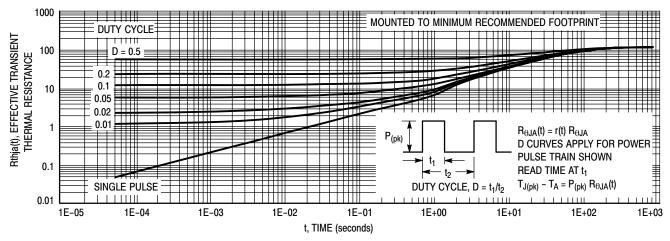


Figure 14. Thermal Response – Various Duty Cycles

ORDERING INFORMATION

Order Number	Package	Shipping [†]
NTD78N03	DPAK	75 Units/Rail
NTD78N03G	DPAK (Pb-Free)	75 Units/Rail
NTD78N03T4	DPAK	
NTD78N03T4G	DPAK (Pb-Free)	2500 Tape & Reel
NTD78N03-1	DPAK Straight Lead	
NTD78N03-1G	DPAK Straight Lead (Pb-Free)	75 Units/Rail
NTD78N03-35	DPAK-3 Straight Lead (3.5 ± 0.15 mm)	
NTD78N03-35G	DPAK-3 Straight Lead (3.5 \pm 0.15 mm) (Pb-Free)	75 Units/Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



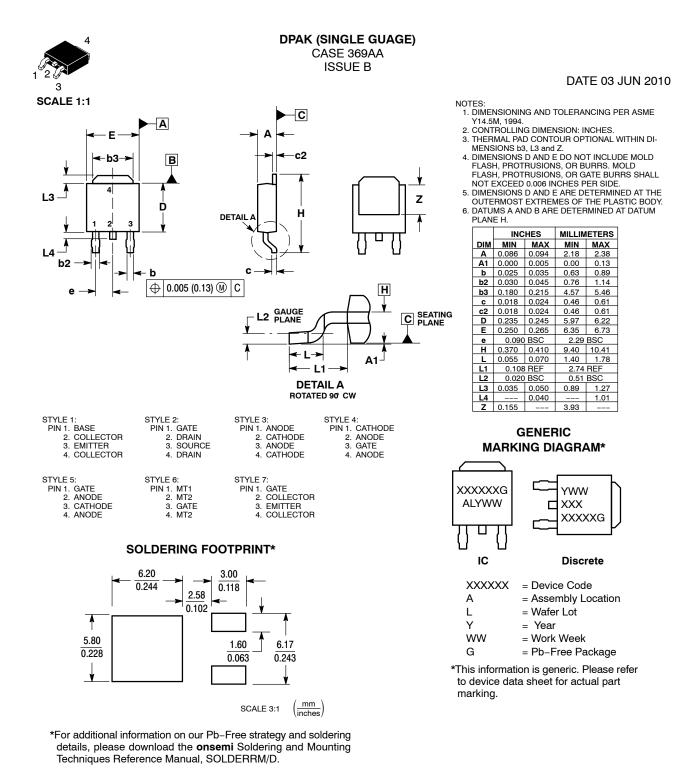
DPAK INSERTION MOUNT CASE 369 ISSUE O DATE 02 JAN 2000 SCALE 1:1 С $B \rightarrow$ NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. Е R MILLIMETERS INCHES л DIM MIN MAX MIN MAX A 0.235 0.250 B 0.250 0.265 5.97 6.35 Δ 6.35 6.73 C 0.086 0.094 D 0.027 0.035 2.19 0.69 2.38 2 3 0.88 S E 0.033 0.040 F 0.037 0.047 0.84 1.01 0.94 -T-1.19 G 0.090 BSC 2.29 BSC SEATING H 0.034 0.040 J 0.018 0.023 0.87 1.01 0.46 0.58 K 0.350 0.380 8.89 9.65 **R** 0.175 0.215 4.45 5.46 0.050 0.090 1.27 J S 2.28 F V 0.030 0.050 н 0.77 1.27 D 3 PL G 🔫 ⊕ 0.13 (0.005) M T

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:		STYLE 5:		STYLE 6:	
PIN 1.	BASE	PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	GATE	PIN 1.	MT1
2.	COLLECTOR	2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE	2.	MT2
3.	EMITTER	3.	SOURCE	3.	ANODE	3.	GATE	3.	CATHODE	3.	GATE
4.	COLLECTOR	4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE	4.	MT2

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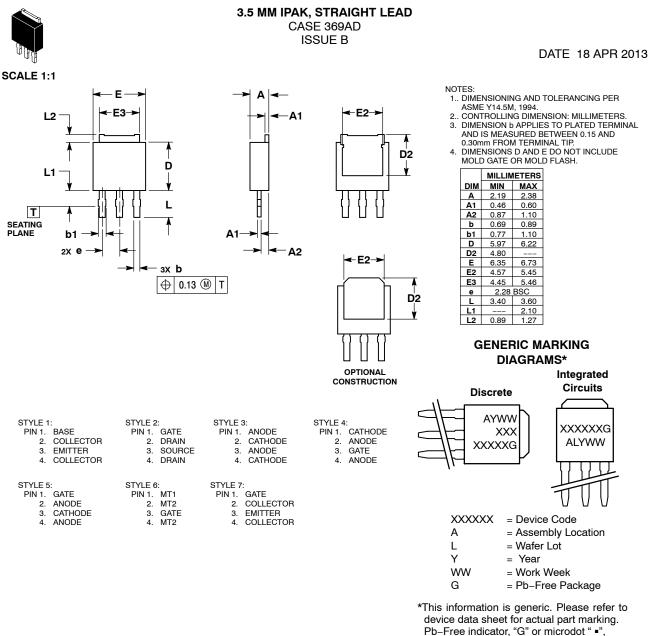


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